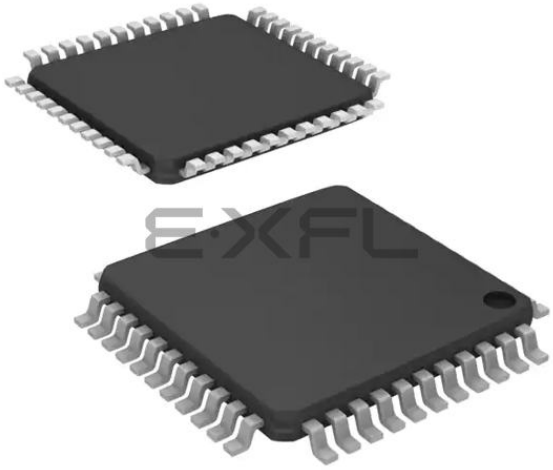

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Peripherals	Brown-out Detect/Reset, LVD, POR, PWM, WDT
Number of I/O	35
Program Memory Size	16KB (5.5K x 24)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 3.6V
Data Converters	A/D 13x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic24fj16ga004-e-pt

4.0 MEMORY ORGANIZATION

As Harvard architecture devices, PIC24F microcontrollers feature separate program and data memory spaces and buses. This architecture also allows the direct access of program memory from the data space during code execution.

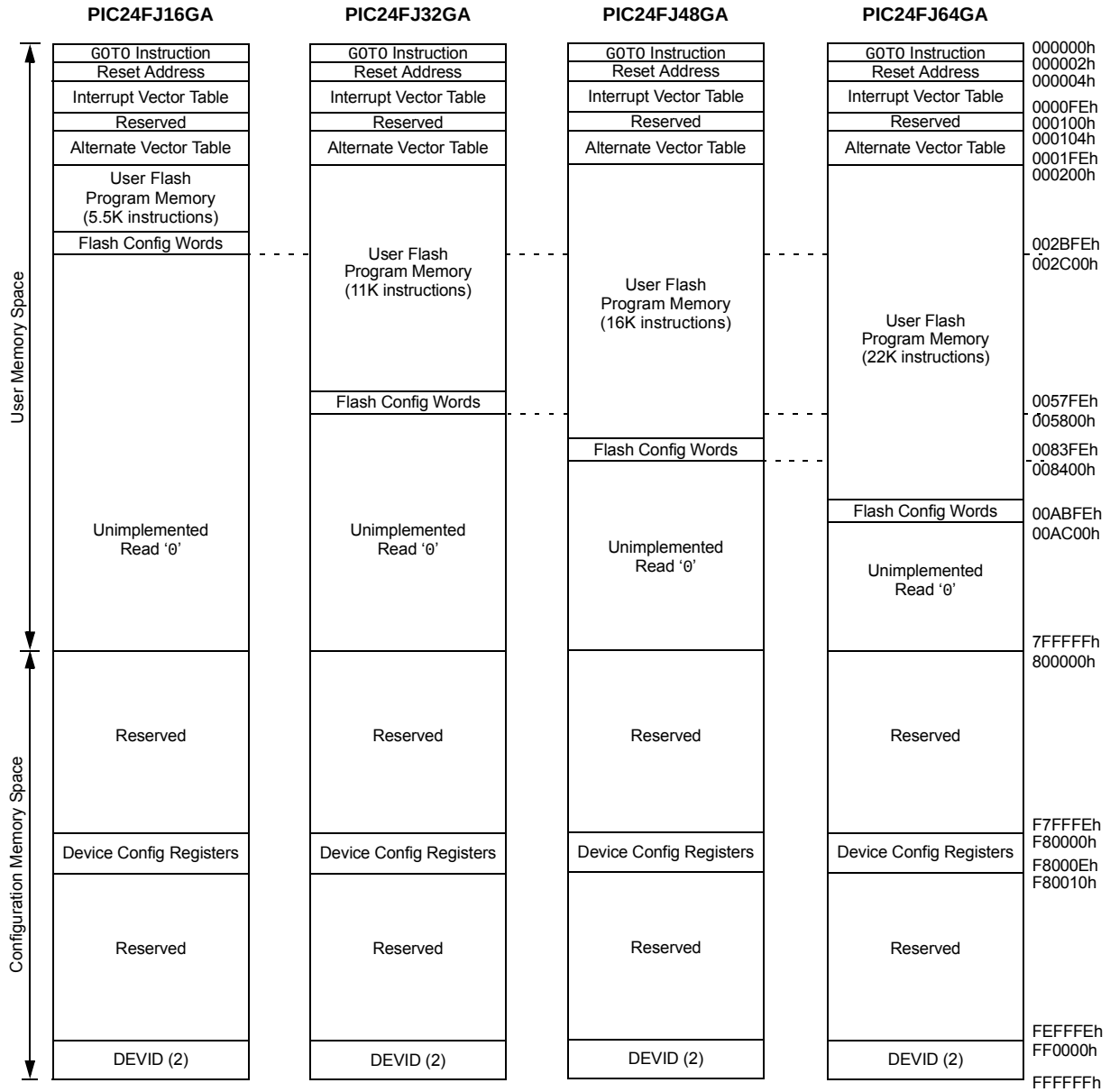
4.1 Program Address Space

The program address memory space of the PIC24FJ64GA004 family devices is 4M instructions. The space is addressable by a 24-bit value derived from either the 23-bit Program Counter (PC) during program execution, or from table operation or data space remapping, as described in **Section 4.3 "Interfacing Program and Data Memory Spaces"**.

User access to the program memory space is restricted to the lower half of the address range (000000h to 7FFFFFh). The exception is the use of TBLRD/TBLWT operations which use TBLPAG<7> to permit access to the Configuration bits and Device ID sections of the configuration memory space.

Memory maps for the PIC24FJ64GA004 family of devices are shown in Figure 4-1.

FIGURE 4-1: PROGRAM SPACE MEMORY MAP FOR PIC24FJ64GA004 FAMILY DEVICES



Note: Memory areas are not shown to scale.

4.2.2 DATA MEMORY ORGANIZATION AND ALIGNMENT

To maintain backward compatibility with PIC® devices and improve data space memory usage efficiency, the PIC24F instruction set supports both word and byte operations. As a consequence of byte accessibility, all Effective Address (EA) calculations are internally scaled to step through word-aligned memory. For example, the core recognizes that Post-Modified Register Indirect Addressing mode [Ws++] will result in a value of Ws + 1 for byte operations and Ws + 2 for word operations.

Data byte reads will read the complete word which contains the byte, using the LSb of any EA to determine which byte to select. The selected byte is placed onto the LSB of the data path. That is, data memory and registers are organized as two parallel, byte-wide entities with shared (word) address decode but separate write lines. Data byte writes only write to the corresponding side of the array or register which matches the byte address.

All word accesses must be aligned to an even address. Misaligned word data fetches are not supported, so care must be taken when mixing byte and word operations, or translating from 8-bit MCU code. If a misaligned read or write is attempted, an address error trap will be generated. If the error occurred on a read, the instruction underway is completed; if it occurred on a write, the instruction will be executed but the write will not occur. In either case, a trap is then executed, allowing the system and/or user to examine the machine state prior to execution of the address Fault.

All byte loads into any W register are loaded into the Least Significant Byte. The Most Significant Byte is not modified.

A Sign-Extend (SE) instruction is provided to allow users to translate 8-bit signed data to 16-bit signed values. Alternatively, for 16-bit unsigned data, users can clear the MSB of any W register by executing a Zero-Extend (ZE) instruction on the appropriate address.

Although most instructions are capable of operating on word or byte data sizes, it should be noted that some instructions operate only on words.

4.2.3 NEAR DATA SPACE

The 8-Kbyte area between 0000h and 1FFFh is referred to as the Near Data Space. Locations in this space are directly addressable via a 13-bit absolute address field within all memory direct instructions. The remainder of the data space is addressable indirectly. Additionally, the whole data space is addressable using MOV instructions, which support Memory Direct Addressing with a 16-bit address field.

4.2.4 SFR SPACE

The first 2 Kbytes of the Near Data Space, from 0000h to 07FFh, are primarily occupied with Special Function Registers (SFRs). These are used by the PIC24F core and peripheral modules for controlling the operation of the device.

SFRs are distributed among the modules that they control and are generally grouped together by module. Much of the SFR space contains unused addresses; these are read as '0'. A diagram of the SFR space, showing where SFRs are actually implemented, is shown in Table 4-2. Each implemented area indicates a 32-byte region where at least one address is implemented as an SFR. A complete listing of implemented SFRs, including their addresses, is shown in Tables 4-3 through 4-24.

TABLE 4-2: IMPLEMENTED REGIONS OF SFR DATA SPACE

	SFR Space Address							
	xx00	**xx20**	**xx40**	**xx60**	**xx80**	**xxA0**	**xxC0**	**xxE0**
000h	Core			ICN	Interrupts			—
100h	Timers		Capture	—	Compare	—	—	—
200h	I^2C™	UART	SPI		—	—	I/O	
300h	A/D		—	—	—	—	—	—
400h	—	—	—	—	—	—	—	—
500h	—	—	—	—	—	—	—	—
600h	PMP	RTC/Comp	CRC	—	PPS			
700h	—	—	System	NVM/PMD	—	—	—	—

Legend: — = No implemented SFRs in this block

TABLE 4-21: PERIPHERAL PIN SELECT REGISTER MAP (PPS)

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
RPINR0	0680	—	—	—	INT1R4	INT1R3	INT1R2	INT1R1	INT1R0	—	—	—	—	—	—	—	—	1F00
RPINR1	0682	—	—	—	—	—	—	—	—	—	—	—	INT2R4	INT2R3	INT2R2	INT2R1	INT2R0	001F
RPINR3	0686	—	—	—	T3CKR4	T3CKR3	T3CKR2	T3CKR1	T3CKR0	—	—	—	T2CKR4	T2CKR3	T2CKR2	T2CKR1	T2CKR0	1F1F
RPINR4	0688	—	—	—	T5CKR4	T5CKR3	T5CKR2	T5CKR1	T5CKR0	—	—	—	T4CKR4	T4CKR3	T4CKR2	T4CKR1	T4CKR0	1F1F
RPINR7	068E	—	—	—	IC2R4	IC2R3	IC2R2	IC2R1	IC2R0	—	—	—	IC1R4	IC1R3	IC1R2	IC1R1	IC1R0	1F1F
RPINR8	0690	—	—	—	IC4R4	IC4R3	IC4R2	IC4R1	IC4R0	—	—	—	IC3R4	IC3R3	IC3R2	IC3R1	IC3R0	1F1F
RPINR9	0692	—	—	—	—	—	—	—	—	—	—	—	IC5R4	IC5R3	IC5R2	IC5R1	IC5R0	001F
RPINR11	0696	—	—	—	OCFBR4	OCFBR3	OCFBR2	OCFBR1	OCFBR0	—	—	—	OCFAR4	OCFAR3	OCFAR2	OCFAR1	OCFAR0	1F1F
RPINR18	06A4	—	—	—	U1CTSR4	U1CTSR3	U1CTSR2	U1CTSR1	U1CTSR0	—	—	—	U1RXR4	U1RXR3	U1RXR2	U1RXR1	U1RXR0	1F1F
RPINR19	06A6	—	—	—	U2CTSR4	U2CTSR3	U2CTSR2	U2CTSR1	U2CTSR0	—	—	—	U2RXR4	U2RXR3	U2RXR2	U2RXR1	U2RXR0	1F1F
RPINR20	06A8	—	—	—	SCK1R4	SCK1R3	SCK1R2	SCK1R1	SCK1R0	—	—	—	SDI1R4	SDI1R3	SDI1R2	SDI1R1	SDI1R0	1F1F
RPINR21	06AA	—	—	—	—	—	—	—	—	—	—	—	SS1R4	SS1R3	SS1R2	SS1R1	SS1R0	001F
RPINR22	06AC	—	—	—	SCK2R4	SCK2R3	SCK2R2	SCK2R1	SCK2R0	—	—	—	SDI2R4	SDI2R3	SDI2R2	SDI2R1	SDI2R0	1F1F
RPINR23	06AE	—	—	—	—	—	—	—	—	—	—	—	SS2R4	SS2R3	SS2R2	SS2R1	SS2R0	001F
RPOR0	06C0	—	—	—	RP1R4	RP1R3	RP1R2	RP1R1	RP1R0	—	—	—	RP0R4	RP0R3	RP0R2	RP0R1	RP0R0	0000
RPOR1	06C2	—	—	—	RP3R4	RP3R3	RP3R2	RP3R1	RP3R0	—	—	—	RP2R4	RP2R3	RP2R2	RP2R1	RP2R0	0000
RPOR2	06C4	—	—	—	RP5R4	RP5R3	RP5R2	RP5R1	RP5R0	—	—	—	RP4R4	RP4R3	RP4R2	RP4R1	RP4R0	0000
RPOR3	06C6	—	—	—	RP7R4	RP7R3	RP7R2	RP7R1	RP7R0	—	—	—	RP6R4	RP6R3	RP6R2	RP6R1	RP6R0	0000
RPOR4	06C8	—	—	—	RP9R4	RP9R3	RP9R2	RP9R1	RP9R0	—	—	—	RP8R4	RP8R3	RP8R2	RP8R1	RP8R0	0000
RPOR5	06CA	—	—	—	RP11R4	RP11R3	RP11R2	RP11R1	RP11R0	—	—	—	RP10R4	RP10R3	RP10R2	RP10R1	RP10R0	0000
RPOR6	06CC	—	—	—	RP13R4	RP13R3	RP13R2	RP13R1	RP13R0	—	—	—	RP12R4	RP12R3	RP12R2	RP12R1	RP12R0	0000
RPOR7	06CE	—	—	—	RP15R4	RP15R3	RP15R2	RP15R1	RP15R0	—	—	—	RP14R4	RP14R3	RP14R2	RP14R1	RP14R0	0000
RPOR8	06D0	—	—	—	RP17R4(1)	RP17R3(1)	RP17R2(1)	RP17R1(1)	RP17R0(1)	—	—	—	RP16R4(1)	RP16R3(1)	RP16R2(1)	RP16R1(1)	RP16R0(1)	0000
RPOR9	06D2	—	—	—	RP19R4(1)	RP19R3(1)	RP19R2(1)	RP19R1(1)	RP19R0(1)	—	—	—	RP18R4(1)	RP18R3(1)	RP18R2(1)	RP18R1(1)	RP18R0(1)	0000
RPOR10	06D4	—	—	—	RP21R4(1)	RP21R3(1)	RP21R2(1)	RP21R1(1)	RP21R0(1)	—	—	—	RP20R4(1)	RP20R3(1)	RP20R2(1)	RP20R1(1)	RP20R0(1)	0000
RPOR11	06D6	—	—	—	RP23R4(1)	RP23R3(1)	RP23R2(1)	RP23R1(1)	RP23R0(1)	—	—	—	RP22R4(1)	RP22R3(1)	RP22R2(1)	RP22R1(1)	RP22R0(1)	0000
RPOR12	06D8	—	—	—	RP25R4(1)	RP25R3(1)	RP25R2(1)	RP25R1(1)	RP25R0(1)	—	—	—	RP24R4(1)	RP24R3(1)	RP24R2(1)	RP24R1(1)	RP24R0(1)	0000

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

Note 1: These bits are only available on 44-pin devices; otherwise, they read as '0'.

4.3.2 DATA ACCESS FROM PROGRAM MEMORY USING TABLE INSTRUCTIONS

The TBLRDL and TBLWTL instructions offer a direct method of reading or writing the lower word of any address within the program space without going through data space. The TBLRDH and TBLWTH instructions are the only method to read or write the upper 8 bits of a program space word as data.

The PC is incremented by two for each successive 24-bit program word. This allows program memory addresses to directly map to data space addresses. Program memory can thus be regarded as two 16-bit word-wide address spaces, residing side by side, each with the same address range. TBLRDL and TBLWTL access the space which contains the least significant data word, and TBLRDH and TBLWTH access the space which contains the upper data byte.

Two table instructions are provided to move byte or word-sized (16-bit) data to and from program space. Both function as either byte or word operations.

1. TBLRDL (Table Read Low): In Word mode, it maps the lower word of the program space location (P<15:0>) to a data address (D<15:0>).

   In Byte mode, either the upper or lower byte of the lower program word is mapped to the lower byte of a data address. The upper byte is selected when byte select is '1'; the lower byte is selected when it is '0'.

2. TBLRDH (Table Read High): In Word mode, it maps the entire upper word of a program address (P<23:16>) to a data address. Note that D<15:8>, the 'phantom' byte, will always be '0'.

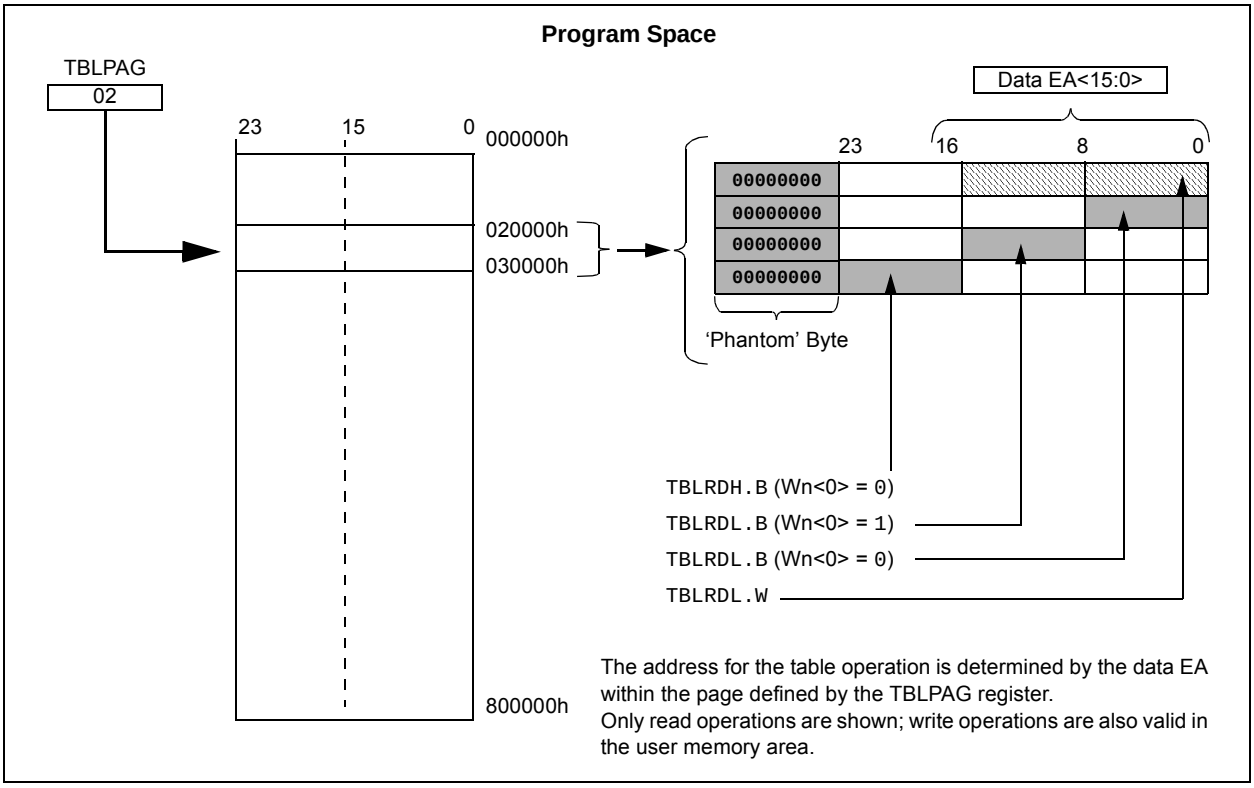
   In Byte mode, it maps the upper or lower byte of the program word to D<7:0> of the data address, as above. Note that the data will always be '0' when the upper 'phantom' byte is selected (Byte Select = 1).

In a similar fashion, two table instructions, TBLWTH and TBLWTL, are used to write individual bytes or words to a program space address. The details of their operation are explained in **Section 5.0 "Flash Program Memory"**.

For all table operations, the area of program memory space to be accessed is determined by the Table Memory Page Address register (TBLPAG). TBLPAG covers the entire program memory space of the device, including user and configuration spaces. When TBLPAG<7> = 0, the table page is located in the user memory space. When TBLPAG<7> = 1, the page is located in configuration space.

Note:	Only table read operations will execute in the configuration memory space, and only then, in implemented areas, such as the Device ID. Table write operations are not allowed.

FIGURE 4-6: ACCESSING PROGRAM MEMORY WITH TABLE INSTRUCTIONS



NOTES:

7.0 INTERRUPT CONTROLLER

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the *"PIC24F Family Reference Manual"*, **"Interrupts"** (DS39707).

The PIC24F interrupt controller reduces the numerous peripheral interrupt request signals to a single interrupt request signal to the PIC24F CPU. It has the following features:

- Up to 8 processor exceptions and software traps
- 7 user-selectable priority levels
- Interrupt Vector Table (IVT) with up to 118 vectors
- A unique vector for each interrupt or exception source
- Fixed priority within a specified user priority level
- Alternate Interrupt Vector Table (AIVT) for debug support
- Fixed interrupt entry and return latencies

7.1 Interrupt Vector Table

The Interrupt Vector Table (IVT) is shown in Figure 7-1. The IVT resides in program memory, starting at location, 000004h. The IVT contains 126 vectors, consisting of 8 non-maskable trap vectors, plus up to 118 sources of interrupt. In general, each interrupt source has its own vector. Each interrupt vector contains a 24-bit wide address. The value programmed into each interrupt vector location is the starting address of the associated Interrupt Service Routine (ISR).

Interrupt vectors are prioritized in terms of their natural priority; this is linked to their position in the vector table. All other things being equal, lower addresses have a higher natural priority. For example, the interrupt associated with Vector 0 will take priority over interrupts at any other vector address.

PIC24FJ64GA004 family devices implement non-maskable traps and unique interrupts. These are summarized in Table 7-1 and Table 7-2.

7.1.1 ALTERNATE INTERRUPT VECTOR TABLE

The Alternate Interrupt Vector Table (AIVT) is located after the IVT, as shown in Figure 7-1. Access to the AIVT is provided by the ALTIVT control bit (INTCON2<15>). If the ALTIVT bit is set, all interrupt and exception processes will use the alternate vectors instead of the default vectors. The alternate vectors are organized in the same manner as the default vectors.

The AIVT supports emulation and debugging efforts by providing a means to switch between an application and a support environment without requiring the interrupt vectors to be reprogrammed. This feature also enables switching between applications for evaluation of different software algorithms at run time. If the AIVT is not needed, the AIVT should be programmed with the same addresses used in the IVT.

7.2 Reset Sequence

A device Reset is not a true exception because the interrupt controller is not involved in the Reset process. The PIC24F devices clear their registers in response to a Reset which forces the PC to zero. The microcontroller then begins program execution at location, 000000h. The user programs a GOTO instruction at the Reset address, which redirects program execution to the appropriate start-up routine.

Note: Any unimplemented or unused vector locations in the IVT and AIVT should be programmed with the address of a default interrupt handler routine that contains a RESET instruction.

REGISTER 7-7: IFS2: INTERRUPT FLAG STATUS REGISTER 2

U-0	U-0	R/W-0	U-0	U-0	U-0	R/W-0	U-0
—	—	PMPIF	—	—	—	OC5IF	—
bit 15							bit 8

R/W-0	R/W-0	R/W-0	U-0	U-0	U-0	R/W-0	R/W-0
IC5IF	IC4IF	IC3IF	—	—	—	SPI2IF	SPF2IF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15-14 **Unimplemented:** Read as ‘0’

bit 13 **PMPIF:** Parallel Master Port Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 12-10 **Unimplemented:** Read as ‘0’

bit 9 **OC5IF:** Output Compare Channel 5 Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 8 **Unimplemented:** Read as ‘0’

bit 7 **IC5IF:** Input Capture Channel 5 Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 6 **IC4IF:** Input Capture Channel 4 Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 5 **IC3IF:** Input Capture Channel 3 Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 4-2 **Unimplemented:** Read as ‘0’

bit 1 **SPI2IF:** SPI2 Event Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

bit 0 **SPF2IF:** SPI2 Fault Interrupt Flag Status bit
1 = Interrupt request has occurred
0 = Interrupt request has not occurred

REGISTER 11-1: T1CON: TIMER1 CONTROL REGISTER

R/W-0	U-0	R/W-0	U-0	U-0	U-0	U-0	U-0
TON	—	TSIDL	—	—	—	—	—
bit 15							bit 8

U-0	R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	U-0
—	TGATE	TCKPS1	TCKPS0	—	TSYNC	TCS	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **TON:** Timer1 On bit
1 = Starts 16-bit Timer1
0 = Stops 16-bit Timer1

bit 14 **Unimplemented:** Read as '0'

bit 13 **TSIDL:** Timer1 Stop in Idle Mode bit
1 = Discontinues module operation when device enters Idle mode
0 = Continues module operation in Idle mode

bit 12-7 **Unimplemented:** Read as '0'

bit 6 **TGATE:** Timer1 Gated Time Accumulation Enable bit
When TCS = 1:
This bit is ignored.
When TCS = 0:
1 = Gated time accumulation is enabled
0 = Gated time accumulation is disabled

bit 5-4 **TCKPS<1:0>:** Timer1 Input Clock Prescale Select bits
11 = 1:256
10 = 1:64
01 = 1:8
00 = 1:1

bit 3 **Unimplemented:** Read as '0'

bit 2 **TSYNC:** Timer1 External Clock Input Synchronization Select bit
When TCS = 1:
1 = Synchronizes external clock input
0 = Does not synchronize external clock input
When TCS = 0:
This bit is ignored.

bit 1 **TCS:** Timer1 Clock Source Select bit
1 = External clock from T1CK pin (on the rising edge)
0 = Internal clock (FOSC/2)

bit 0 **Unimplemented:** Read as '0'

15.0 SERIAL PERIPHERAL INTERFACE (SPI)

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the *"PIC24F Family Reference Manual"*, **"Serial Peripheral Interface (SPI)"** (DS39699)

The Serial Peripheral Interface (SPI) module is a synchronous serial interface useful for communicating with other peripheral or microcontroller devices. These peripheral devices may be serial EEPROMs, shift registers, display drivers, A/D Converters, etc. The SPI module is compatible with the SPI and SIOP Motorola® interfaces.

The module supports operation in two buffer modes. In Standard mode, data is shifted through a single serial buffer. In Enhanced Buffer mode, data is shifted through an 8-level FIFO buffer.

Note: Do not perform read-modify-write operations (such as bit-oriented instructions) on the SPIxBUF register in either Standard or Enhanced Buffer mode.

The module also supports a basic framed SPI protocol while operating in either Master or Slave mode. A total of four framed SPI configurations are supported.

The SPI serial interface consists of four pins:

- SDIx: Serial Data Input
- SDOx: Serial Data Output
- SCKx: Shift Clock Input or Output
- $\overline{SSx}$: Active-Low Slave Select or Frame Synchronization I/O Pulse

The SPI module can be configured to operate using 2, 3 or 4 pins. In the 3-pin mode, $\overline{SSx}$ is not used. In the 2-pin mode, both SDOx and $\overline{SSx}$ are not used.

Block diagrams of the module in Standard and Enhanced modes are shown in Figure 15-1 and Figure 15-2.

Depending on the pin count, PIC24FJ64GA004 family devices offer one or two SPI modules on a single device.

Note: In this section, the SPI modules are referred to together as SPIx or separately as SPI1 and SPI2. Special Function Registers will follow a similar notation. For example, SPIxCON1 or SPIxCON2 refers to the control register for the SPI1 or SPI2 module.

To set up the SPIx module for the Standard Master mode of operation:

1. If using interrupts:
   a) Clear the SPIxIF bit in the respective IFSx register.
   b) Set the SPIxIE bit in the respective IECx register.
   c) Write the SPIxIP bits in the respective IPCx register to set the interrupt priority.
2. Write the desired settings to the SPIxCON1 and SPIxCON2 registers with the MSTEN bit (SPIxCON1<5>) = 1.
3. Clear the SPIROV bit (SPIxSTAT<6>).
4. Enable SPIx operation by setting the SPIEN bit (SPIxSTAT<15>).
5. Write the data to be transmitted to the SPIxBUF register. Transmission (and reception) will start as soon as data is written to the SPIxBUF register.

To set up the SPIx module for the Standard Slave mode of operation:

1. Clear the SPIxBUF register.
2. If using interrupts:
   a) Clear the SPIxIF bit in the respective IFSx register.
   b) Set the SPIxIE bit in the respective IECx register.
   c) Write the SPIxIP bits in the respective IPCx register to set the interrupt priority.
3. Write the desired settings to the SPIxCON1 and SPIxCON2 registers with the MSTEN bit (SPIxCON1<5>) = 0.
4. Clear the SMP bit (SPIxCON1<9>).
5. If the CKE bit is set, then the SSEN bit (SPIxCON1<7>) must be set to enable the $\overline{SSx}$ pin.
6. Clear the SPIROV bit (SPIxSTAT<6>).
7. Enable SPIx operation by setting the SPIEN bit (SPIxSTAT<15>).

FIGURE 15-5: SPIx MASTER, FRAME MASTER CONNECTION DIAGRAM

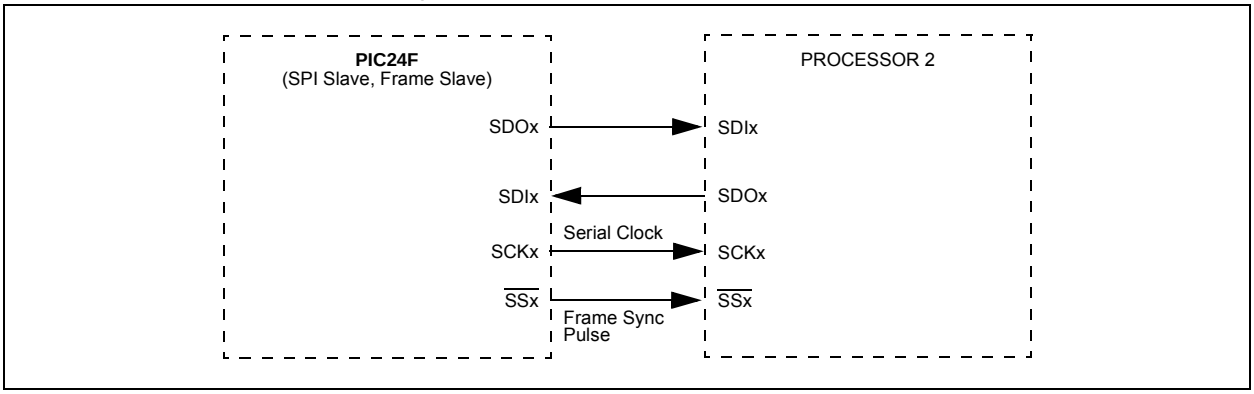


FIGURE 15-6: SPIx MASTER, FRAME SLAVE CONNECTION DIAGRAM

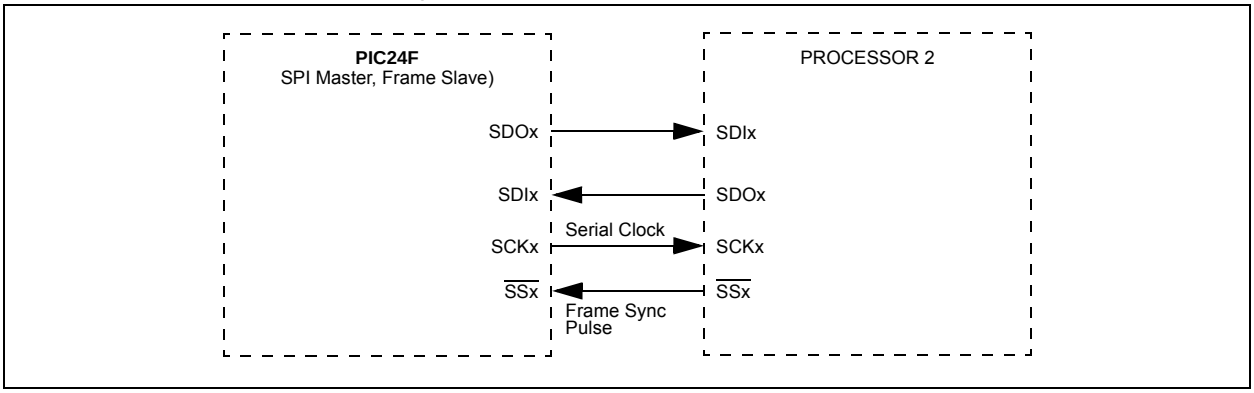


FIGURE 15-7: SPIx SLAVE, FRAME MASTER CONNECTION DIAGRAM

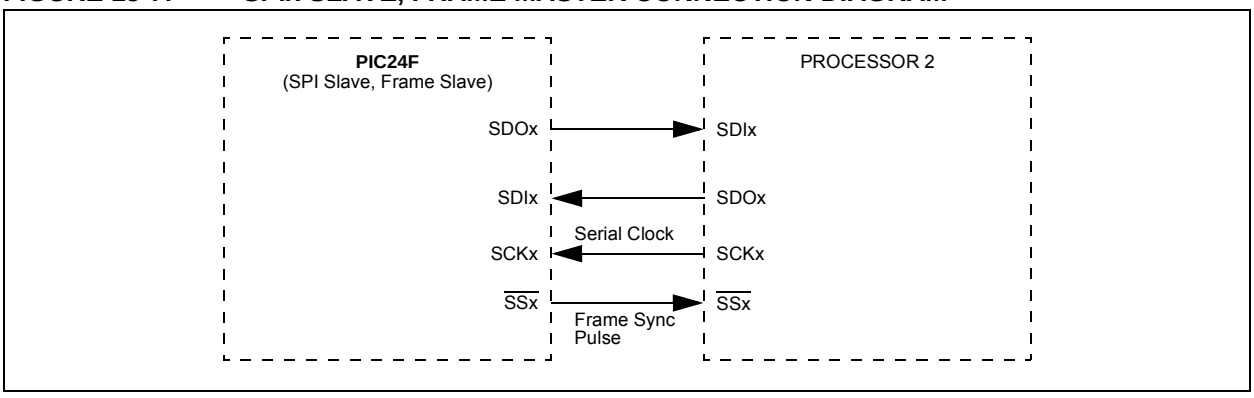


FIGURE 15-8: SPIx SLAVE, FRAME SLAVE CONNECTION DIAGRAM

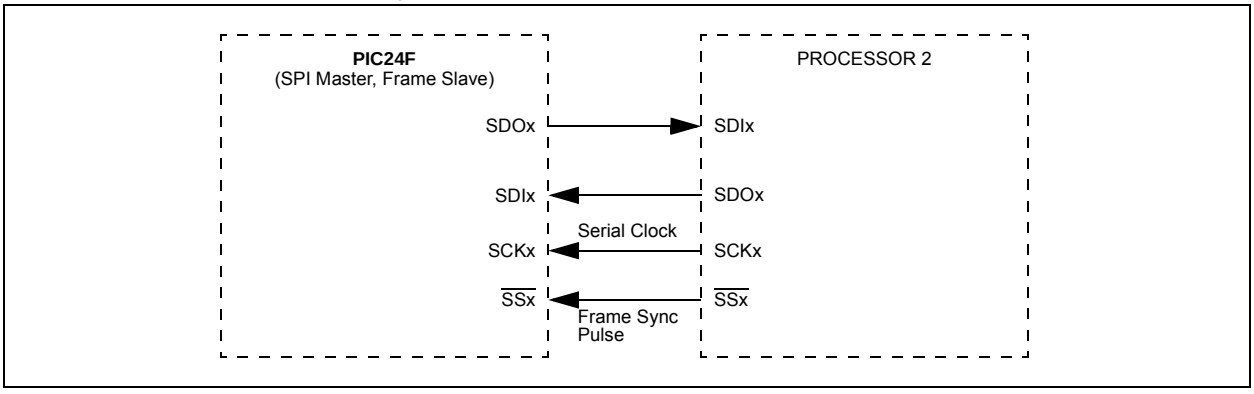
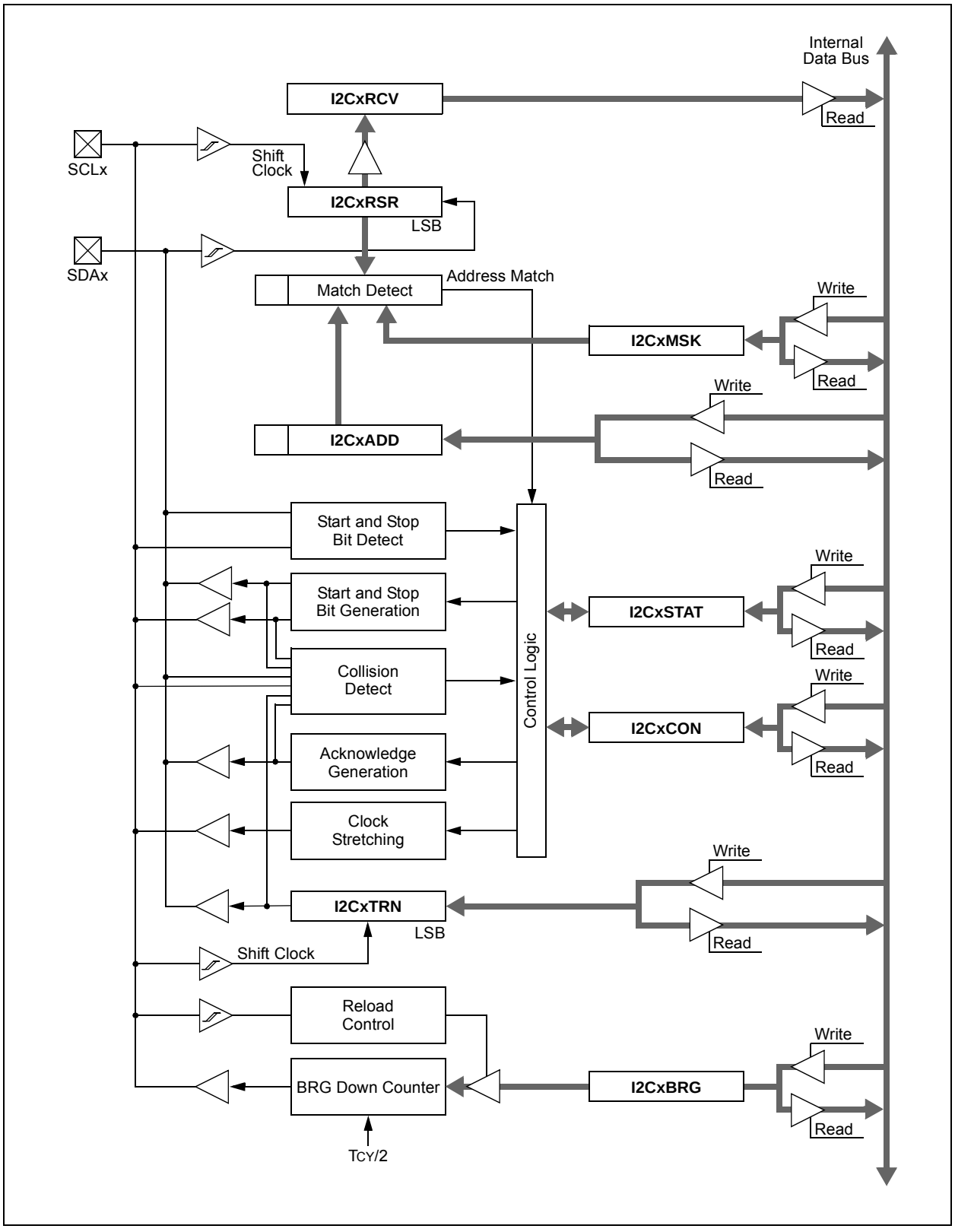


FIGURE 16-1: I²C™ BLOCK DIAGRAM



16.3 Setting Baud Rate When Operating as a Bus Master

To compute the Baud Rate Generator reload value, use Equation 16-1.

EQUATION 16-1: COMPUTING BAUD RATE RELOAD VALUE(1)

$$FSCL = \frac{FCY}{I2CxBRG + 1 + \frac{FCY}{10,000,000}}$$

or

$$I2CxBRG = \left(\frac{FCY}{FSCL} - \frac{FCY}{10,000,000}\right) - 1$$

Note 1: Based on FCY = FOSC/2; Doze mode and PLL are disabled.

16.4 Slave Address Masking

The I2CxMSK register (Register 16-3) designates address bit positions as "don't care" for both 7-Bit and 10-Bit Addressing modes. Setting a particular bit location (= 1) in the I2CxMSK register causes the slave module to respond whether the corresponding address bit value is a '0' or a '1'. For example, when I2CxMSK is set to '00100000', the slave module will detect both addresses, '00000000' and '00100000'.

To enable address masking, the IPMI (Intelligent Peripheral Management Interface) must be disabled by clearing the IPMIEN bit (I2CxCON<11>).

Note: As a result of changes in the I²C™ protocol, the addresses in Table 16-2 are reserved and will not be Acknowledged in Slave mode. This includes any address mask settings that include any of these addresses.

TABLE 16-1: I²C™ CLOCK RATES(1)

Required System FSCL	FCY	I2CxBRG Value		Actual FSCL
		(Decimal)	(Hexadecimal)	
100 kHz	16 MHz	157	9D	100 kHz
100 kHz	8 MHz	78	4E	100 kHz
100 kHz	4 MHz	39	27	99 kHz
400 kHz	16 MHz	37	25	404 kHz
400 kHz	8 MHz	18	12	404 kHz
400 kHz	4 MHz	9	9	385 kHz
400 kHz	2 MHz	4	4	385 kHz
1 MHz	16 MHz	13	D	1.026 MHz
1 MHz	8 MHz	6	6	1.026 MHz
1 MHz	4 MHz	3	3	0.909 MHz

Note 1: Based on FCY = FOSC/2; Doze mode and PLL are disabled.

TABLE 16-2: I²C™ RESERVED ADDRESSES(1)

Slave Address	R/$\overline{W}$ Bit	Description
0000 000	0	General Call Address(2)
0000 000	1	Start Byte
0000 001	x	Cbus Address
0000 010	x	Reserved
0000 011	x	Reserved
0000 1xx	x	HS Mode Master Code
1111 1xx	x	Reserved
1111 0xx	x	10-Bit Slave Upper Byte(3)

Note 1: The address bits listed here will never cause an address match, independent of the address mask settings.

2: The address will be Acknowledged only if GCEN = 1.

3: A match on this address can only occur on the upper byte in 10-Bit Addressing mode.

19.1 RTCC Module Registers

The RTCC module registers are organized into three categories:

- RTCC Control Registers
- RTCC Value Registers
- Alarm Value Registers

19.1.1 REGISTER MAPPING

To limit the register interface, the RTCC Timer and Alarm Time registers are accessed through corresponding register pointers. The RTCC Value register window (RTCVALH and RTCVALL) uses the RTCPTR<1:0> bits (RCFGCAL<9:8>) to select the desired Timer register pair (see Table 19-1).

By writing the RTCVALH byte, the RTCC Pointer value (the RTCPTR<1:0> bits) decrements by one until the bits reach '00'. Once they reach '00', the MINUTES and SECONDS value will be accessible through RTCVALH and RTCVALL until the pointer value is manually changed.

TABLE 19-1: RTCVAL REGISTER MAPPING

RTCPTR <1:0>	RTCC Value Register Window	
	RTCVAL<15:8>	RTCVAL<7:0>
00	MINUTES	SECONDS
01	WEEKDAY	HOURS
10	MONTH	DAY
11	—	YEAR

The Alarm Value register window (ALRMVALH and ALRMVALL) uses the ALRMPTR bits (ALCFGRPT<9:8>) to select the desired Alarm register pair (see Table 19-2).

By writing the ALRMVALH byte, the Alarm Pointer value (the ALRMPTR<1:0> bits) decrements by one until the bits reach '00'. Once they reach '00', the ALRMMIN and ALRMSEC value will be accessible through ALRMVALH and ALRMVALL until the pointer value is manually changed.

TABLE 19-2: ALRMVAL REGISTER MAPPING

ALRMPTR <1:0>	Alarm Value Register Window	
	ALRMVAL<15:8>	ALRMVAL<7:0>
00	ALRMMIN	ALRMSEC
01	ALRMWD	ALRMHR
10	ALRMMNTH	ALRMDAY
11	—	—

Considering that the 16-bit core does not distinguish between 8-bit and 16-bit read operations, the user must be aware that when reading either the ALRMVALH or ALRMVALL, the bytes will decrement the ALRMPTR<1:0> value. The same applies to the RTCVALH or RTCVALL bytes with the RTCPTR<1:0> being decremented.

Note:	This only applies to read operations and not write operations.

19.1.2 WRITE LOCK

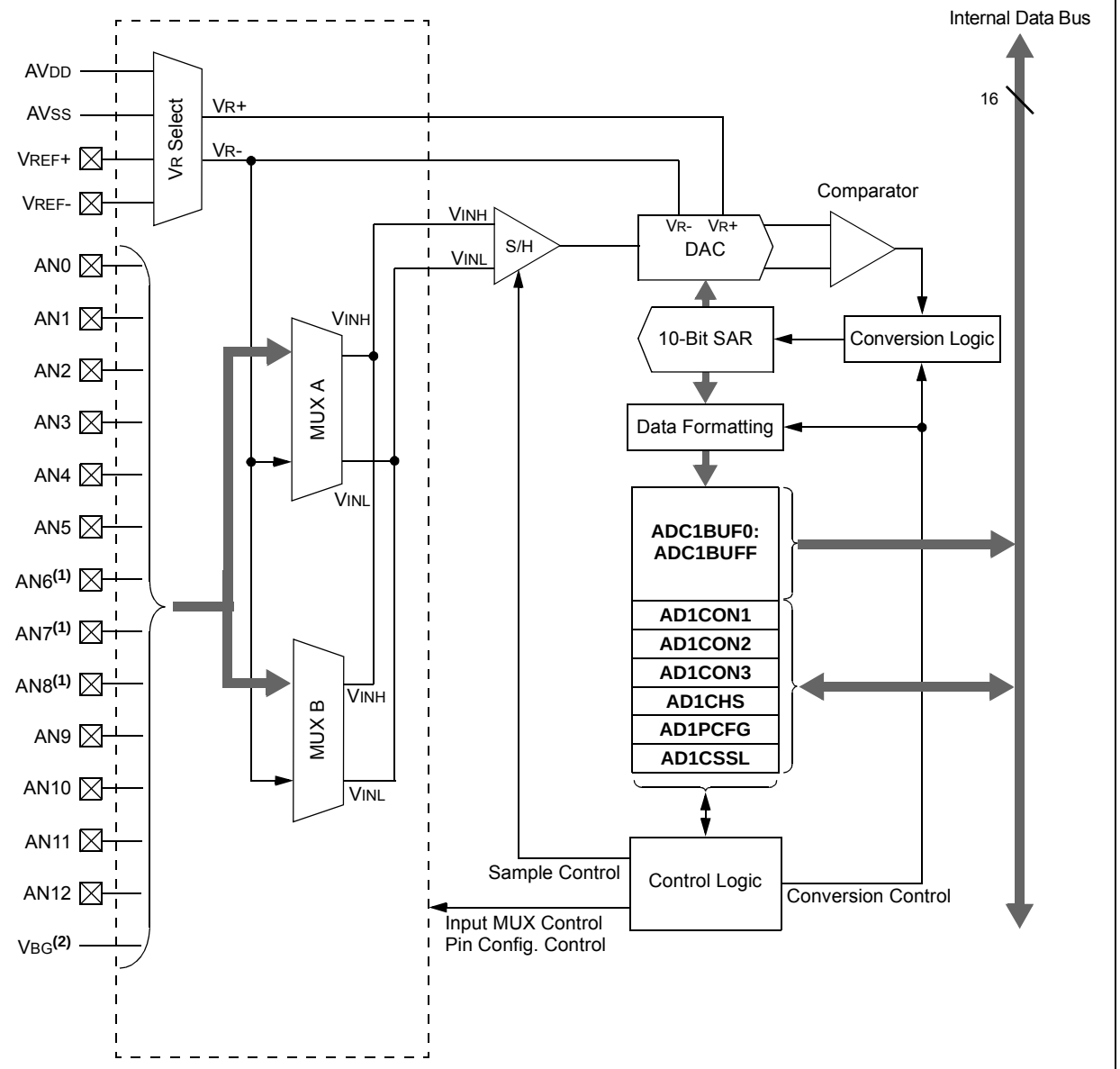
In order to perform a write to any of the RTCC Timer registers, the RTCWREN bit (RCFGCAL<13>) must be set (refer to Example 19-1).

Note:	To avoid accidental writes to the timer, it is recommended that the RTCWREN bit (RCFGCAL<13>) is kept clear at any other time. For the RTCWREN bit to be set, there is only 1 instruction cycle time window allowed between the 55h/AA sequence and the setting of RTCWREN; therefore, it is recommended that code follow the procedure in Example 19-1.

EXAMPLE 19-1: SETTING THE RTCWREN BIT

```
asm  volatile("push w7");
asm  volatile("push w8");
asm  volatile("disi #5");
asm  volatile("mov #0x55, w7");
asm  volatile("mov w7, _NVMKEY");
asm  volatile("mov #0xAA, w8");
asm  volatile("mov w8, _NVMKEY");
asm  volatile("bset _RCFGCAL, #13");  //set the RTCWREN bit
asm  volatile("pop w8");
asm  volatile("pop w7");
```

FIGURE 21-1: 10-BIT HIGH-SPEED A/D CONVERTER BLOCK DIAGRAM



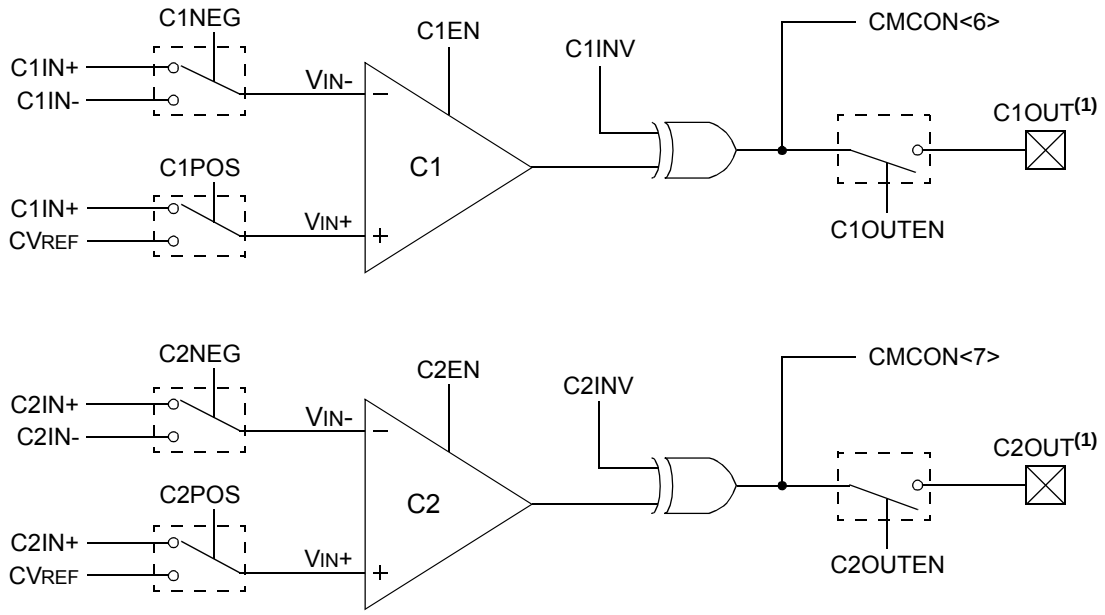
Note 1: Analog Channels, AN6 through AN8, are available on 44-pin devices only.

2: Band Gap Voltage (V_{BG}) reference is internally connected to Analog Channel AN15, which does not appear on any pin.

22.0 COMPARATOR MODULE

Note: This data sheet summarizes the features of this group of PIC24F devices. It is not intended to be a comprehensive reference source. For more information, refer to the *"PIC24F Family Reference Manual"*, **"Output Compare"** (DS39706).

FIGURE 22-1: COMPARATOR I/O OPERATING MODES



Note 1: This peripheral's outputs must be assigned to an available RPn pin before use. Please see **Section 10.4 "Peripheral Pin Select (PPS)"** for more information.

24.2.3 ON-CHIP REGULATOR AND POR

When the voltage regulator is enabled, it takes approximately 10 μs for it to generate output. During this time, designated as TVREG, code execution is disabled. TVREG is applied every time the device resumes operation after any power-down, including Sleep mode. TVREG is determined by the setting of the PMSLP bit (RCON<8>) and the WUTSELx Configuration bits (CW2<14:13>). For more information on TVREG, see **Section 27.0 "Electrical Characteristics"**.

If the regulator is disabled, a separate Power-up Timer (PWRT) is automatically enabled. The PWRT adds a fixed delay of 64 ms nominal delay at device start-up (POR or BOR only). When waking up from Sleep with the regulator disabled, TVREG is used to determine the wake-up time. To decrease the device wake-up time when operating with the regulator disabled, the PMSLP bit can be set.

24.2.4 POWER-UP REQUIREMENTS

The on-chip regulator is designed to meet the power-up requirements for the device. If the application does not use the regulator, then strict power-up conditions must be adhered to. While powering up, VDDCORE must never exceed VDD by 0.3 volts.

Note:	For more information, see **Section 27.0 "Electrical Characteristics"**.

24.2.5 VOLTAGE REGULATOR STANDBY MODE

When enabled, the on-chip regulator always consumes a small incremental amount of current over IDD/IPD, including when the device is in Sleep mode, even though the core digital logic does not require power. To provide additional savings in applications where power resources are critical, the regulator automatically places itself into Standby mode whenever the device goes into Sleep mode. This feature is controlled by the PMSLP bit (RCON<8>). By default, this bit is cleared, which enables Standby mode.

For select PIC24FJ64GA004 family devices, the time required for regulator wake-up from Standby mode is controlled by the WUTSEL<1:0> Configuration bits (CW2<14:13>). The default wake-up time for all devices is 190 μs. Where the WUTSELx Configuration bits are implemented, a fast wake-up option is also available. When WUTSEL<1:0> = 01, the regulator wake-up time is 25 μs.

Note:	This feature is implemented only on PIC24FJ64GA004 family devices with a major silicon revision level of B or later (DEVREV register value is 3042h or greater).

When the regulator's Standby mode is turned off (PMSLP = 1), Flash program memory stays powered in Sleep mode and the device can wake-up in less than 10 μs. When PMSLP is set, the power consumption while in Sleep mode will be approximately 40 μA higher than power consumption when the regulator is allowed to enter Standby mode.

24.3 Watchdog Timer (WDT)

For PIC24FJ64GA004 family devices, the WDT is driven by the LPRC oscillator. When the WDT is enabled, the clock source is also enabled.

The nominal WDT clock source from LPRC is 31 kHz. This feeds a prescaler that can be configured for either 5-bit (divide-by-32) or 7-bit (divide-by-128) operation. The prescaler is set by the FWPSA Configuration bit. With a 31 kHz input, the prescaler yields a nominal WDT Time-out period (TWDT) of 1 ms in 5-bit mode or 4 ms in 7-bit mode.

A variable postscaler divides down the WDT prescaler output and allows for a wide range of time-out periods. The postscaler is controlled by the WDTPS<3:0> Configuration bits (CW1<3:0>), which allow the selection of a total of 16 settings, from 1:1 to 1:32,768. Using the prescaler and postscaler, time-out periods, ranges from 1 ms to 131 seconds can be achieved.

The WDT, prescaler and postscaler are reset:

- On any device Reset
- On the completion of a clock switch, whether invoked by software (i.e., setting the OSWEN bit after changing the NOSCx bits) or by hardware (i.e., Fail-Safe Clock Monitor)
- When a PWRSAV instruction is executed (i.e., Sleep or Idle mode is entered)
- When the device exits Sleep or Idle mode to resume normal operation
- By a CLRWDT instruction during normal execution

If the WDT is enabled, it will continue to run during Sleep or Idle modes. When the WDT time-out occurs, the device will wake the device and code execution will continue from where the PWRSAV instruction was executed. The corresponding SLEEP or IDLE bits (RCON<3:2>) will need to be cleared in software after the device wakes up.

The WDT Flag bit, WDTO (RCON<4>), is not automatically cleared following a WDT time-out. To detect subsequent WDT events, the flag must be cleared in software.

Note:	The CLRWDT and PWRSAV instructions clear the prescaler and postscaler counts when executed.

27.0 ELECTRICAL CHARACTERISTICS

This section provides an overview of the PIC24FJ64GA004 family electrical characteristics. Additional information will be provided in future revisions of this document as it becomes available.

Absolute maximum ratings for the PIC24FJ64GA004 family are listed below. Exposure to these maximum rating conditions for extended periods may affect device reliability. Functional operation of the device at these, or any other conditions above the parameters indicated in the operation listings of this specification, is not implied.

Absolute Maximum Ratings(†)

Ambient temperature under bias ..... -40°C to +135°C
Storage temperature ..... -65°C to +150°C
Voltage on V_{DD} with respect to V_{SS} ..... -0.3V to +4.0V
Voltage on any combined analog and digital pin and $\overline{MCLR}$, with respect to V_{SS} ..... -0.3V to (V_{DD} + 0.3V)
Voltage on any digital only pin with respect to V_{SS} ..... -0.3V to +6.0V
Voltage on V_{DDCORE} with respect to V_{SS} ..... -0.3V to +3.0V
Maximum current out of V_{SS} pin ..... 300 mA
Maximum current into V_{DD} pin **(Note 1)** ..... 250 mA
Maximum output current sunk by any I/O pin ..... 25 mA
Maximum output current sourced by any I/O pin ..... 25 mA
Maximum current sunk by all ports ..... 200 mA
Maximum current sourced by all ports **(Note 1)** ..... 200 mA

Note 1: Maximum allowable current is a function of device maximum power dissipation (see Table 27-1).

† **NOTICE:** Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operation listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

TABLE 27-4: DC CHARACTERISTICS: OPERATING CURRENT (IDD)

DC CHARACTERISTICS			Standard Operating Conditions: 2.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended			
Parameter No.	**Typical(1)**	**Max**	**Units**	**Conditions**		
Operating Current (IDD): PMD Bits are Set(2)						
DC20	0.650	0.850	mA	-40°C	2.0V(3)	1 MIPS
DC20a	0.650	0.850	mA	+25°C		
DC20b	0.650	0.850	mA	+85°C		
DC20c	0.650	0.850	mA	+125°C		
DC20d	1.2	1.6	mA	-40°C	3.3V(4)	
DC20e	1.2	1.6	mA	+25°C		
DC20f	1.2	1.6	mA	+85°C		
DC20g	1.2	1.6	mA	+125°C		
DC23	2.6	3.4	mA	-40°C	2.0V(3)	4 MIPS
DC23a	2.6	3.4	mA	+25°C		
DC23b	2.6	3.4	mA	+85°C		
DC23c	2.6	3.4	mA	+125°C		
DC23d	4.1	5.4	mA	-40°C	3.3V(4)	
DC23e	4.1	5.4	mA	+25°C		
DC23f	4.1	5.4	mA	+85°C		
DC23g	4.1	5.4	mA	+125°C		
DC24	13.5	17.6	mA	-40°C	2.5V(3)	16 MIPS
DC24a	13.5	17.6	mA	+25°C		
DC24b	13.5	17.6	mA	+85°C		
DC24c	13.5	17.6	mA	+125°C		
DC24d	15	20	mA	-40°C	3.3V(4)	
DC24e	15	20	mA	+25°C		
DC24f	15	20	mA	+85°C		
DC24g	15	20	mA	+125°C		
DC31	13	17	μA	-40°C	2.0V(3)	LPRC (31 kHz)
DC31a	13	17	μA	+25°C		
DC31b	20	26	μA	+85°C		
DC31c	40	50	μA	+125°C		
DC31d	54	70	μA	-40°C	3.3V(4)	
DC31e	54	70	μA	+25°C		
DC31f	95	124	μA	+85°C		
DC31g	120	260	μA	+125°C		

Note 1: Data in "Typical" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors, such as I/O pin loading and switching rate, oscillator type, internal code execution pattern and temperature, also have an impact on the current consumption. The test conditions for all IDD measurements are as follows: OSCI driven with external square wave from rail-to-rail. All I/O pins are configured as inputs and pulled to VDD.
$\overline{MCLR}$ = VDD; WDT and FSCM are disabled. CPU, SRAM, program memory and data memory are operational. No peripheral modules are operating and all of the Peripheral Module Disable (PMD) bits are set.

3: On-chip voltage regulator is disabled (DISVREG tied to VDD).

4: On-chip voltage regulator is enabled (DISVREG tied to VSS). Low-Voltage Detect (LVD) and Brown-out Detect (BOD) are enabled.

TABLE 27-5: DC CHARACTERISTICS: IDLE CURRENT (IIDLE) (CONTINUED)

DC CHARACTERISTICS			Standard Operating Conditions: 2.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended			
Parameter No.	**Typical(1)**	**Max**	**Units**	**Conditions**		
Idle Current (IIDLE): Core Off, Clock On Base Current, PMD Bits are Set(2)						
DC51	4	6	µA	-40°C	2.0V(3)	LPRC (31 kHz)
DC51a	4	6	µA	+25°C		
DC51b	8	16	µA	+85°C		
DC51c	20	50	µA	+125°C		
DC51d	42	55	µA	-40°C	3.3V(4)	
DC51e	42	55	µA	+25°C		
DC51f	70	91	µA	+85°C		
DC51g	100	180	µA	+125°C		

Note 1: Data in "Typical" column is at 3.3V, +25°C unless otherwise stated. Parameters are for design guidance only and are not tested.

2: The test conditions for all IIDLE measurements are as follows: OSCI driven with external square wave from rail-to-rail. All I/O pins are configured as inputs and pulled to VDD. $\overline{MCLR}$ = VDD; WDT and FSCM are disabled. CPU, SRAM, program memory and data memory are operational. No peripheral modules are operating and all of the Peripheral Module Disable (PMD) bits are set.

3: On-chip voltage regulator is disabled (DISVREG tied to VDD).

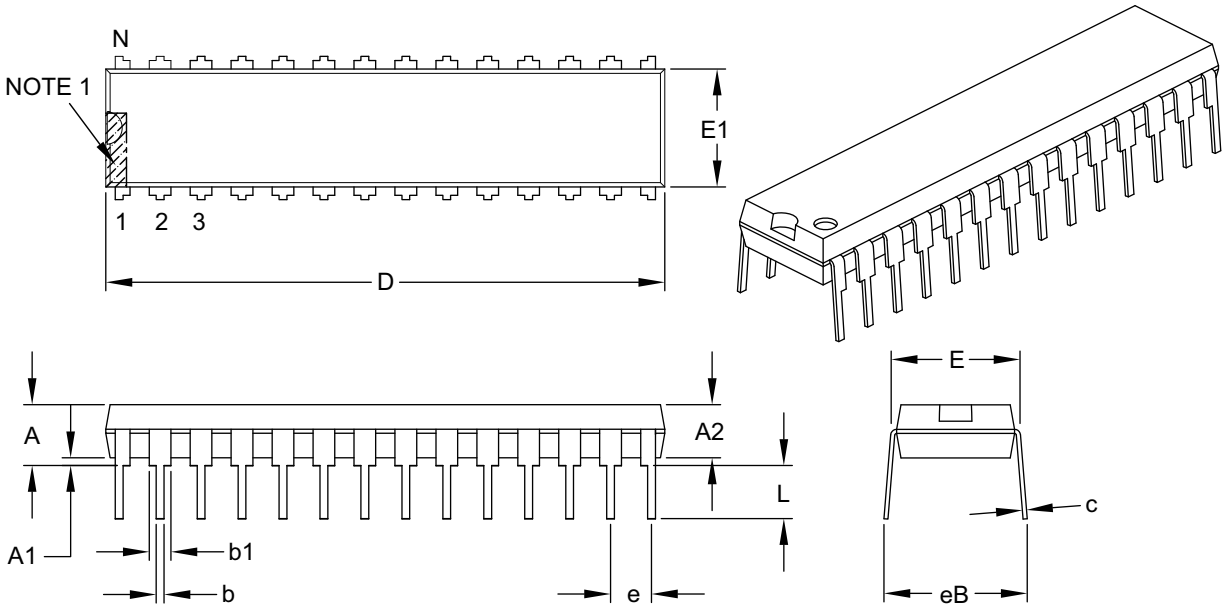
4: On-chip voltage regulator is enabled (DISVREG tied to VSS). Low-Voltage Detect (LVD) and Brown-out Detect (BOD) are enabled.

28.2 Package Details

The following sections give the technical details of the packages.

28-Lead Skinny Plastic Dual In-Line (SP) – 300 mil Body [SPDIP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		INCHES		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		28	
Pitch	e		.100 BSC	
Top to Seating Plane	A	–	–	.200
Molded Package Thickness	A2	.120	.135	.150
Base to Seating Plane	A1	.015	–	–
Shoulder to Shoulder Width	E	.290	.310	.335
Molded Package Width	E1	.240	.285	.295
Overall Length	D	1.345	1.365	1.400
Tip to Seating Plane	L	.110	.130	.150
Lead Thickness	c	.008	.010	.015
Upper Lead Width	b1	.040	.050	.070
Lower Lead Width	b	.014	.018	.022
Overall Row Spacing §	eB	–	–	.430

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.
2. § Significant Characteristic.
3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" per side.
4. Dimensioning and tolerancing per ASME Y14.5M.

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-070B